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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/699,226	10/31/2003	Hyungjun Kim	YOR920030208US1 3395	
75	90 05/31/2006		EXAM	INER
David Aker			CHEN, BRET P	
23 Southern Ro Hartedale, NY	·· ·	·	ART UNIT PAPER NUMBER	
,			1762	
			DATE MAILED: 05/31/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)			
Office Action Summary		10/699,226	KIM ET AL.			
		Examiner	Art Unit			
		B. Chen	1762			
Period fo	The MAILING DATE of this communication apport	pears on the cover sheet with the c	orrespondence address			
A SH WHIC - Exte after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DON'S INTERPRETATION OF THE MAILING THE MAIL	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status						
1)⊠	Responsive to communication(s) filed on 3/10/	′ 06.				
		action is non-final.				
·	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.					
Dispositi	ion of Claims					
4)⊠)⊠ Claim(s) <u>1-3,6-9,11-19 and 26-28</u> is/are pending in the application.					
	4a) Of the above claim(s) is/are withdrawn from consideration.					
5)	Claim(s) is/are allowed.					
6)⊠	Claim(s) <u>1-3, 6-9, 11-19, 26-28</u> is/are rejected.					
7)	Claim(s) is/are objected to.					
8)□	Claim(s) are subject to restriction and/o	r election requirement.				
Applicati	on Papers					
9)□	The specification is objected to by the Examine	r.				
	The drawing(s) filed on is/are: a) acc		Examiner.			
	Applicant may not request that any objection to the					
	Replacement drawing sheet(s) including the correct	ion is required if the drawing(s) is obj	ected to. See 37 CFR 1.121(d).			
11)	The oath or declaration is objected to by the Ex	aminer. Note the attached Office	Action or form PTO-152.			
Priority u	ınder 35 U.S.C. § 119					
a)[Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureause the attached detailed Office action for a list of the priorical priorical detailed of the priorical priorical priorical detailed of the attached detailed of the certification for a list of the priorical priorical detailed of the priorical detailed of th	s have been received. s have been received in Application ity documents have been receive (PCT Rule 17.2(a)).	on No ed in this National Stage			
2) 🔲 Notic 3) 📐 Inforr	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) r No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:				

DETAILED ACTION

Claims 1-3, 6-9, 11-19, 26-28 are pending in this application. Amended claims 1-3, 6, 11, 13, 15-16; canceled claims 4-5, 10, 20-25; and newly added claims 26-28 are noted.

The amendment dated 3/10/06 has been entered and carefully considered. In view of said amendment, the 112 rejection and the previous art rejection have been withdrawn.

Claim Rejections - 35 USC § 103

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claims 1-3, 6-9, 11-19, 26-28 are rejected under 35 U.S.C. 103(a) as being unpatentable over Arkles et al. (5,919,531). Arkles discloses a method of forming tantalum and tantalum-based films by chemical vapor deposition onto a substrate includes introducing into a deposition chamber: (i) a substrate; (ii) a source precursor in the vapor state; and (iii) at least one carrier gas, and maintaining the temperature of the substrate within the chamber as from about 70.degree. C. to about 675.degree. C. for a period of time sufficient to deposit a film comprising tantalum on the substrate (col.4 lines 19-33) followed by the deposition of a second film comprising tantalum to form a multilayered structure (col.4 lines 34-44). The deposition method can be a plasma method (col.5 lines 36-37), the plasma can contain hydrogen and nitrogen (col.12 line 66 – col.13 line 2), and tantalum pentachloride can be used as a precursor, albeit at a higher processing temperature (col.7 lines 19-49). A silicon substrate is utilized (col.5 line 67 – col.6 line 2) and can be used as a diffusion barrier (col.6 line 24). Arkles teaches a range of processing time, temperature, and pressures (col.8 lines 10-22 and col.12 lines 1-4) as

well as the use of a carrier gas (col.11 lines 58-67). In one embodiment, a tantalum nitride layer can be formed followed by pure tantalum by varying nitrogen (col.9 lines 28-35) and can be done in alternating or sequential fashion (col.9 lines 47-53). However, the reference fails to explicitly teach reducing the concentration of nitrogen.

It is noted above that the reference specifically teaches of depositing pure tantalum film or tantalum nitride alloy film followed by a series of tantalum-based films, such as pure tantalum or tantalum nitride are deposited onto the coated substrate, preferably with increasing nitrogen concentrations. It is further noted that to form tantalum nitride films by plasma CVD, a nitrogen containing reactant gas must be introduced (col.12 lines 45-50) and that nitrogen is not utilized to form pure tantalum (col.12 lines 34-42). If one skilled in the art wanted to form the tantalum nitride layer first followed by the pure tantalum layer, then nitrogen would have to be eliminated as taught by Arkles. Hence, it would have been obvious to one skilled in the art to reduce the concentration of nitrogen to form a second pure tantalum layer as taught by Arkles.

The limitations of claims 2-3, 6-9, 11-19, 26-28 have been addressed above.

Response to Arguments

Applicant's arguments with respect to the pending claims have been considered but are moot in view of the new ground(s) of rejection.

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

Art Unit: 1762

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to B. Chen whose telephone number is (571) 272-1417. The examiner can normally be reached on 7:30am - 4:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Timothy Meeks can be reached on (571) 272-1423. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Bc 5/26/06

BRET CHEN
PRIMARY EXAMINER